edRock

1 Description

The RedRock® RR122-3CU2-515 and RR122-3CU3-515 are digital magnetic sensors ideal for use in medical, industrial, automotive, and consumer applications, based on patented Tunneling Magnetoresistance (TMR) technology with seamless CMOS integration.

The RR122-3CU2-515 and RR122-3CU3-515 feature an operate sensitivity of 10 G (1.0 mT) with a bipolar magnetic field response. The wide supply voltage range from 1.7 up to 5.5 V is ideal for applications ranging from small battery-powered electronics to industrial machinery. They have low average current drain (600 nA) for an active magnetic sensor with an operating frequency up to 10 kHz and high operating temperature ranges from -40°C up to 125°C.

The RR122-3CU2-515 and RR122-3CU3-515 have an available "turbo" mode that can be toggled via an input pin when faster than usual sampling is required. When provided a logic "high" signal from a microcontroller or similar, it switches the base internal clock frequency up to 10 kHz. This is particularly useful for maximizing battery life in applications involving intermittent high speed rotation sensing, where a slow clock is sufficient to detect the start of rotation but then a faster sampling period is needed to ensure that no rotations are missed.

2 Features

- ▶ Operate sensitivity from -10 G to +10 G
- Lowest Average Current < 600 nA</p>
- ▶ Wide Supply Voltage Ranges Available Down to 1.7V, Up to 5.5V
- Bipolar Latching Push-Pull Response
- Operating Frequencies up to 10 kHz
- ► Toggleable 10 kHz "Turbo Mode" Available
- Temperature Rated up to 125°C
- ▶ RoHS & REACH Compliant

3 Applications

- ► Proximity Detection
- ► Linear Position Sensing
- ► Rotary Sensing
- ► Fluid Level Detection
- ► Door & Lid Closure Detection
- Utility Meters
- ► Portable Medical Devices
- Motor Controllers
- ► Consumer Electronics
- ► Wake-Up µProcessor

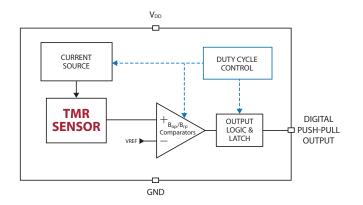
Device Information

Part Series	Package	Body Size (mm)	Temp Rating °C
RR122-3CU2-515	SOT-23-5	2.9 x 1.6 x 1.2	-40 to +85
RR122-3CU3-515	SOT-23-5	2.9 x 1.6 x 1.2	-40 to +125



Device Nomenclature

Functional Block Diagram for Digital Push-Pull Output



Ordering Information RR122-X X X X-Y YY

	Γ.	Γ-	Г ⁻	
Series				

Magnetic Polarit	y Response
1 = Omnipolar	3 = Bipolar/Latch
2 = Unipolar	

Magnetic Sensitivity (G)

A: Op 9, Rel 5 E: Op 15, Rel 10 B: Op 30, Rel 20 F: Op 70, Rel 50 C: Op 10, Rel -10 G: Op 100, Rel 70

Clock Frequency (Hz)

1:2	5: 250	9: 10000
2:10	6: 500	U: 100+Turbo (10000)
3: 20	7:2500	

Package 1: SOT-23-3 2: LGA-4 5: SOT-23-5

Output Response 1: Active Low

Supply Voltage (V) 5:17-55

Temp Rating (°C)

2: -40 - +85 3: -40 - +125





4 Specifications

4.1 Absolute Environmental Ratings^{1,2}

Parameters	Units	Min	Тур	Мах
Operating Temperature (T_{OP}) (RR122-3CU2-515)	°C	-40		+85
Operating Temperature (T_{OP}) (RR122-3CU3-515)	°C	-40		+125
Storage Temperature (T _{STG})	°C	-65		+150
Junction Temperature (T _J)	°C			+150
Soldering Temperature (3 cycles, 1 min.) (T _{sol})	°C			+260
ESD Level Human Body Model per JESD22-A114	V	±4000		
ESD Level Charged Device Model (CDM) per JESD22-C1010	V	±500		
Junction-to-Ambient Thermal Resistance (SOT-23-5)	°C/W		202	
Maximum Magnetic Field Exposure (B _{MAX})	G			±600

4.2 Absolute Electrical Ratings^{1,2}

Parameters	Units	Min	Тур	Мах
Supply Voltage (V _{DD})	V	-0.3		6.0
Push-pull Output (Active Low)(V _{OUT_PP})	V	-0.3		V _{DD}
Input and Output Current (I_{IN}/I_{OUT})	mA			±20

Notes:

1. Exceeding Absolute Ratings may cause permanent damage to the device. Exposure at the maximum rated conditions for extended periods of time may also affect device reliability.

2. Unless otherwise specified, all characteristics are measured at 25°C.



ESD Note: This product uses semiconductors that can be damaged by electrostatic discharge (ESD). When handling, proper ESD precautions should be taken to avoid performance degradation or loss of functionality. Damage due to inappropriate handling is not covered under warranty.





4.3 Operating Electrical Characteristics for RR132-3CU2-515 and RR132-3CU3-515¹

Parameters	Units	Min	Тур	Мах
Supply Voltage (V _{DD})	V	+1.7		5.5
Power-On Time $(t_{ON})(V_{DD} > 90\%)$	μs		50	75
Peak Power-On Current	mA			1.4
Output Voltage (High) ³ (V _{OUTH})	V	90% V _{DD}		
Output Voltage (Low) ³ (V _{OUTL})	V			$10\% V_{DD}$
Under Voltage Lockout Threshold Rising V_{DD} ($V_{UVLO-RISE}$)	V		1.60	1.64
Under Voltage Lockout Threshold Falling V_{DD} ($V_{UVLO-FALL}$)	V	1.40	1.53	
Under Voltage Lockout Hysteresis (V _{UV-HYST})	mV		70	
Average Supply Current @ $V_{DD} = 1.7V$, $f_{SW} = 100 \text{ Hz} (I_{DD (AVG)})^2$	μΑ		0.6	
Average Supply Current @ $V_{DD} = 3.0V$, $f_{SW} = 100 \text{ Hz} (I_{DD (AVG)})^2$	μΑ		0.8	
Average Supply Current @ $V_{DD} = 1.7V$, $f_{SW} = 10 \text{ kHz} (I_{DD (AVG)})^2$	μΑ		41.0	
Average Supply Current @ $V_{DD} = 3.0V$, $f_{SW} = 10 \text{ kHz} (I_{DD (AVG)})^2$	μΑ		46.0	

4.4 Operating Characteristics for RR132-3CU2-515 and RR132-3CU3-515¹

Parameters	Units	Min	Тур	Max
NORMAL MODE				
Switching Frequency (f _{sw}) (Base Frequency) ³	Hz		100	
Idle Mode Time (t_{IDLE}) (Base Frequency) ³	ms		10	
Active Mode Time (t_{ACT}) (Base Frequency) ³	μs		1.4	
TURBO MODE				
Switching Frequency (f _{sw}) (Turbo Frequency) ³	kHz		10	
Idle Mode Time (t _{IDLE}) (Turbo Frequency) ³	μs		100	
Active Mode Time (t_{ACT}) (Turbo Frequency) ³	μs		1.4	
TURBO LOGIC CONTROL				
Logic High Threshold (V _{IH})	V	1.2		
Logic Low Threshold (V_{IL})	V			0.5
Input Bias Current (I_{EN})	μA			1.0
Time Delay for 1st Sample After Turbo Mode Enabled	μs		100	110
MAGNETIC				
Operate Point (B _{OPS})	G	-14	-10	-8
Release Point (B _{RPN})	G	8	10	14

Notes:

1. Unless otherwise specified, $V_{DD} = 1.7$ V to 5.5 V, $T_A = -40^{\circ}$ C to $+85^{\circ}$ C (3CU2), -40° C to $+125^{\circ}$ C (3CU3). Typical values are $V_{DD} = 3.0$ V and $T_A = +25^{\circ}$ C.

2. Conditions: t = 10 seconds

3. Turbo Mode Switching Frequency is activated by sending a logic "HIGH" signal to the turbo pin on the device. A logic "LOW" signal will set the switching frequency to the base frequency.

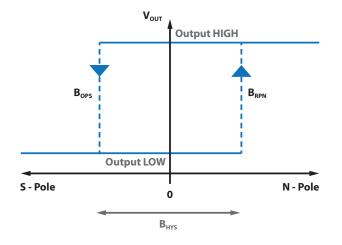
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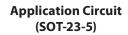
5 Output Response vs. Magnetic Flux

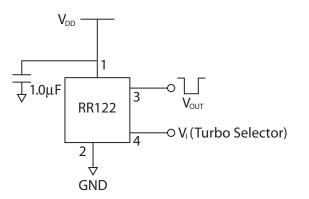


6 Application Information

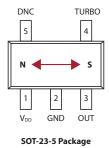
RR122 Push-Pull Output Application Circuit

The output voltage on the RR122 is active low, meaning that while a sufficiently strong magnetic field is present, the output voltage is low. The output voltage can be connected to a digital I/O pin on a microcontroller. A decoupling capacitor between the supply voltage and ground is required with placement close to the magnetic sensor. A capacitor with a value of 1.0µF, placed not more than 10 mm from the sensor, is required.





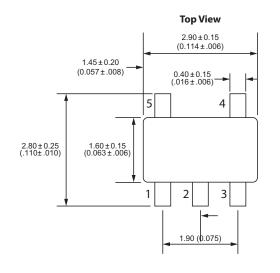
7 Axis of Sensitivity

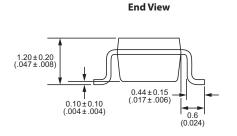




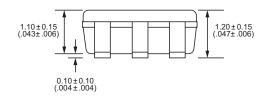


8 Dimensions SOT-23-5 Package Millimeters (Inches)



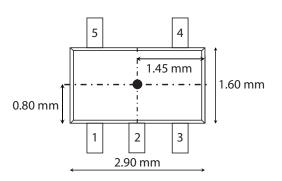


Side View



9 TMR Sensor Location









10 Output Behavior vs. Magnetic Field Diagrams

Output Behavior vs. Magnetic Field - Bipolar

Characteristics	Conditions	Output
South Pole	B < B _{OPS}	Low (ON)
North Pole	B > B _{RPN}	High (OFF)

11 Sample Frequency Selection for Turbo Mode Trims

Characteristics	Conditions	Sample Frequency
Turke Die Insut Voltage	$V_{1} < 0.5 V$	Base Frequency
Turbo Pin Input Voltage	V ₁ > 1.2 V	10 kHz

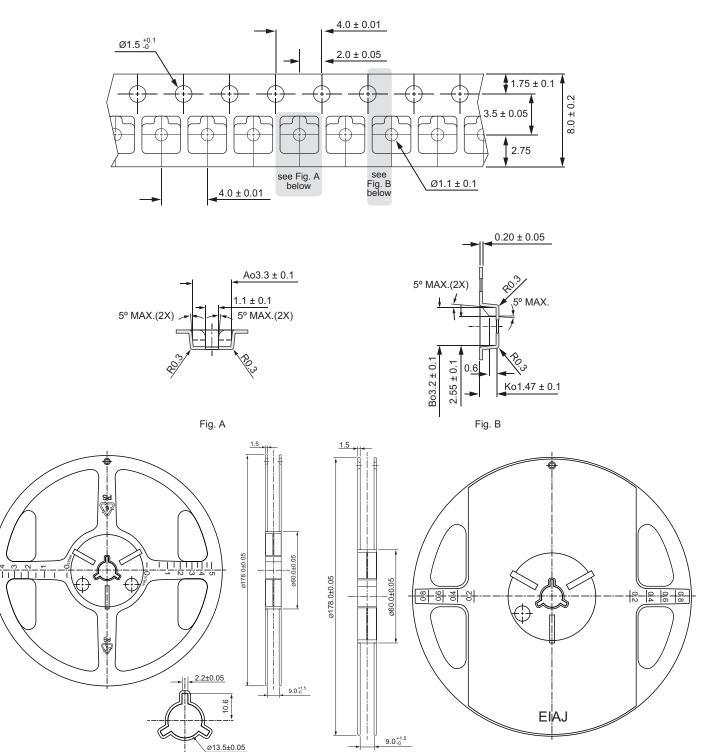




12 TMR Sensor & Switch Packaging

SOT-23-5 Tape & Reel Packaging

Standard packaging is Tape & Reel containing 3,000 pieces. MSL Rating is 1.

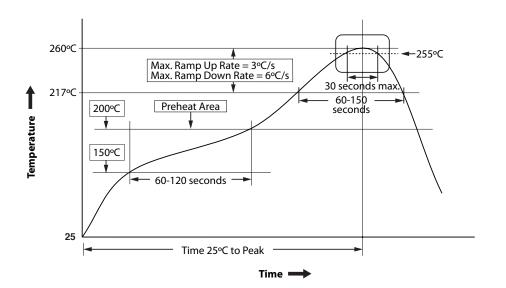




13 Suggested Pb-Free Reflow Profile

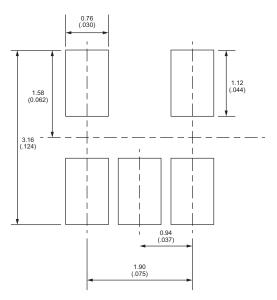
Notes:

- 1. Fully compatible with standard no-lead solder profile, 260 °C for 30 seconds max (3 cycles max).
- 2. Profile shown as example. Users are advised to develop their own board-level profile.
- 3. Suggested Pb-free reflow profile derived from IPC/JEDEC J-STD-020E.
- 4. Temperature tolerance: +0 °C, as measured at any point on the package or leads
- 5. MSL rating of 1 (SOT-23-3 only) compatible with J-STD-020 or equivalent.
- 6. All temperatures refer to the center of the package, measured on the package body surface that is facing up during assembly reflow (e.g., livebug). If parts are reflowed in other than the normal live bug assembly reflow orientation (i.e., dead-bug), Tp shall be within ± 2 °C of the live bug Tp and still meet the Tc requirements, otherwise, the profile shall be adjusted to achieve the latter. To accurately measure actual peak package body temperatures, refer to JEP140 for recommended thermocouple use.
- 7. Reflow profiles in this document are for classification/preconditioning and are not meant to specify board assembly profiles. Actual board assembly profiles should be developed based on specific process needs and board designs and should not exceed the parameters in this table.



14 Suggested Solder Pad Layout

SOT-23-5 Solder Pad Layout





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